ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES*	Material Composit © Copyright 2005. IPC, international and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.	nder both	This docum level parts, t	ent is a declarat	ion of the s encompasse	ubstances es all lower	within the manufactur r level materials for w	rer listed i	tem. Note: if nanufacturer	the item is an as has engineering	sembly with lower responsibility.	
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
Supplier Informa	tion														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi											2023-06-08				
Contact Name	Title - Contact				Phone - Contact*				Email -	Email - Contact*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Steward	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Requester 1	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	version	N	Anufacturing Site		Weight*	UOM	Unit Type	
		NCP339AFCT2G 3A Load S		3A Load Switch	d Switch with Discharge Path		2023-06-08		N	MY1		2.93938	mg	Each	
Manufacturing P	roccess Information	1													
Terminal Plating / Grid Array Material Terr			erminal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperature M		e Max Time at Peak	Temperat	ure Numb	er of Reflow Cy	eles			
SnAgCu CU Alle			U Alloy	y 1			260 C		С	30 seco		ids 3			
Comments															
evel 1 - maximum tim	ie at peak temperature d	luring sol	dering is 10-3	0 seconds											
For more information	regarding material com	position p	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	toHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or n [F] Optionally enter the positive (+				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.94	mg	Supplier	Silicon (Si)	7440-21-3		1.94	mg
Protection coat	0.026	mg		Polyimide	proprietary data		0.026	mg
Solder Ball	0.96	mg	Supplier	Silver (Ag)	7440-22-4		0.0384	mg
			Supplier	Tin (Sn)	7440-31-5		0.9168	mg
			Supplier	Copper (Cu)	7440-50-8		0.0048	mg
UBM Sputter	3.8E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0003	mg
Under Bump Metal	0.013	mg	Supplier	Copper (Cu)	7440-50-8		0.013	mg